

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain to Source Voltage	40	V
V _{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (V _{GS} = 10V)	50	Α
I _D	Pulsed	Figure 4	A
E _{AS}	Single Pulse Avalanche Energy (Note 1)	144	mJ
Б	Power Dissipation	79	W
PD	Derate above 25°C	0.53	W/ºC
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case	1.9	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient, 1in ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8445	FDD8445-F085	TO-252AA	13"	12mm	2500 units

Notes:

1: Starting $T_J = 25^{\circ}$ C, L = 0.18mH, $I_{AS} = 40A$ 2: A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as ON Semiconductor has officially announced in Aug 2014.

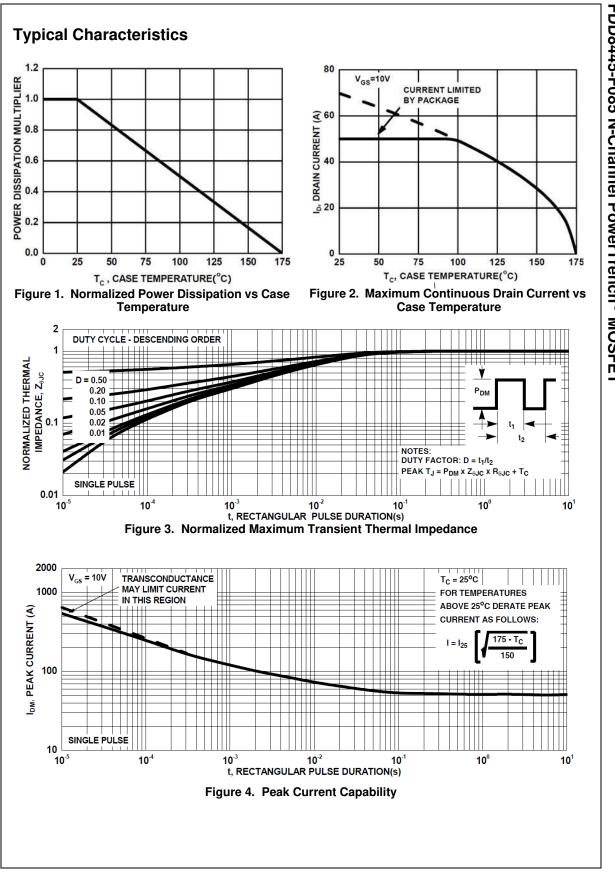
Symbol	Parameter	Test Condition	s	Min	Тур	Max	Units
Off Cha	racteristics						
3 _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$		40	-	-	V
	Zero Gate Voltage Drain Current	V _{DS} = 32V,		-	-	1	1 250 μΑ
I _{DSS}	Zero Gale voltage Drain Current	$V_{GS} = 0V$ T_A	= 150°C	-	-	250	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		2	2.8	4	V
		- 1			1	1	
• GS(th)		$V_{GS} = V_{DS}, D = 230 \mu A$ $I_D = 50A, V_{GS} = 10V$ $I_D = 50A, V_{GS} = 10V$ $T_J = 175^{\circ}C$		-	6.7	8.7	v
DS(on)	Drain to Source On Resistance			-	12.5	16.3	mΩ
Dynam i C _{iss}	ic Characteristics				3040	4050	pF
	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$	-	-	295	390	pF
		f = 1MHz		-	178	270	pF
C _{oss}							
C _{oss} C _{rss}	Reverse Transfer Capacitance Gate Resistance	f = 1MHz		-	1.7	-	Ω
C _{oss} C _{rss} R _G	Reverse Transfer Capacitance	f = 1MHz				- 59	Ω nC
C _{oss} C _{rss} R _G Q _{g(TOT)}	Reverse Transfer Capacitance Gate Resistance	f = 1MHz V _{GS} = 0 to 10V	o = 20V		1.7		
	Reverse Transfer CapacitanceGate ResistanceTotal Gate Charge at 10V	$f = 1 MHz$ $V_{GS} = 0 \text{ to } 10V$ $V_{GS} = 0 \text{ to } 2V$ V_{DD}) = 20V 50A		1.7 45	59	nC

Switching Characteristics

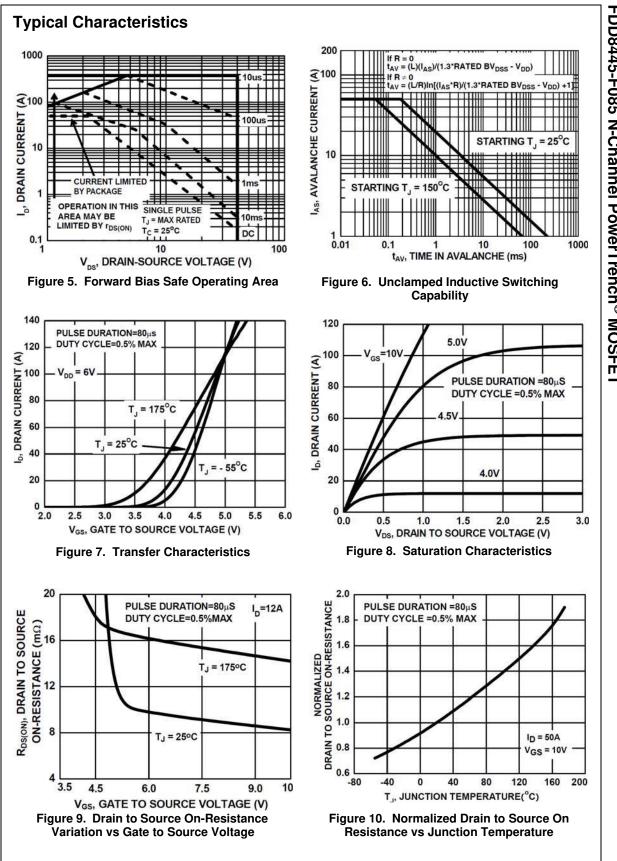
t _{on}	Turn-On Time		-	-	138	ns
t _{d(on)}	Turn-On Delay Time		-	10	-	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 50A$ $V_{GS} = 10V, R_{GS} = 2\Omega$	-	82	-	ns
t _{d(off)}	Turn-Off Delay Time	$v_{GS} = 10v, n_{GS} = 202$	-	26	-	ns
t _f	Fall Time		-	9.6	-	ns
t _{off}	Turn-Off Time		-	-	53	ns

Drain-Source Diode Characteristics

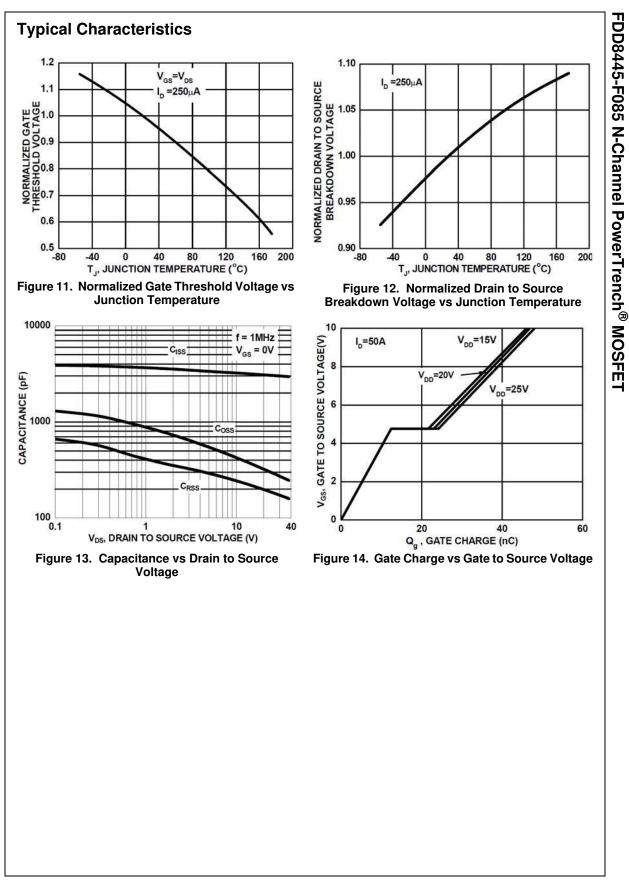
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 50A	-	-	1.25 V	
		I _{SD} = 25A	-	-	1.0	v
t _{rr}	Reverse Recovery Time	$I_{SD} = 50A$, $dI_{SD}/dt = 100A/\mu s$	-	-	39	ns
Q _{rr}	Reverse Recovery Charge		-	-	38	nC



FDD8445-F085 N-Channel PowerTrench[®] MOSFET



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